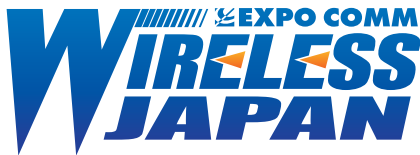


EXPO COMM WIRELESS JAPAN 2008



July 22 **TUE** - 24 **THU**, 2008

10:00am to 5:30pm - Final day close at 5:00pm-

Tokyo Big Sight Tokyo, Japan

Access information

<http://www.bigsight.jp/english/>

The Exhibition Specialized in Wireless / Mobile Technologies and Solutions.

You will find the best mobile solution with latest technologies.

Take this chance to explore the advanced wireless solution and develop new business partnership at EXPO COMM WIRELESS JAPAN 2008.

KEY WORD

▶ Wireless Broadband Technology

WiMAX, / Next Generation PHS / LTE / HSPA / Femtocell / Cognitive Radio / ZigBee / UWB / IEEE802 / Wireless USB / Bluetooth, etc

▶ Mobile Service, Mobile Content

Mobile movie, one segment / full segment broadcasting, Multimedia broadcasting, FMC service, Mobile commerce

▶ Mobile Internet Device / Mobile Terminal

3.5G mobile phone · PHS / Smartphone / Ultra Mobile PC

▶ Semiconductor, Embedded Technology

Semiconductor, Embedded Technology
Image processing / Semiconductor / Module / Mobile OS

▶ Mobile Solution for Enterprise, Mobile Marketing

Mobile solution for business user / Mobile SaaS / Mobile Industrial application / RFID solution / Mobile CRM

CONFERENCE

● Key Note Session

- ▶ Top executive of Japanese mobile carriers as well as a major Mobile Manufacturer will present the future business strategies in Key Note Session.
- ▶ The cutting edge technology services development of mobile broadcasting.

● Short Range Communication

ZigBee Forum / Bluetooth Forum will be held at EXPO COMM WIRELESS JAPAN.

● IEEE802 Forum

- ▶ Pick up the latest trend of IEEE802 wireless standardization for 2days.
- ▶ Schedule to held the most update technical solution seminar for engineers.

● Tools for Sales Promotion & Sales support

Introduce the mobile business application through a case study to make use of mobile for marketing tools.

EXHIBITION

About 180 companies from Japan, Europe, US and Asia will exhibit to promote their latest technologies, solutions and services of Wireless telecommunication.

Gathering the latest technology, service and solution regarding to the Wireless WAN / MAN / LAN / PAN



Registration

Pre-registration is not required for people from overseas.

If you bring your business cards on the day of EXPO, admission will be waived.

The Official
Web Site

<http://www.wjexpo.com>

The Latest Trend Station of Wireless & Mobile business

Nowadays Mobile & Wireless Technology continue to develop and expand the market. On the other hand, the application for enterprise is rapidly growing, such as Mobile SaaS and other applications. EXPO COMM WIRELESS JAPAN 2008 will focus on the latest technology, service, application and solution of Wireless & Mobile broadband and short range communication such as ZigBee, Bluetooth and UWB. EXPO COMM WIRELESS JAPAN 2008 provides the opportunity to see and reach the latest technologies. Please take this opportunity to build new business networking and technical information.

WIRELESS CONFERENCE 2008

Key representative of Wireless & Mobile industry will address the advanced technologies and business strategy.

● Key Note			
A course	Next Generation Wireless Technology and Framework of Terminal Development	Free	English available
B course	Future Vision of Mobile Telecommunication Service	31,500JPYen	Japanese only
● Technical Conference			
C course	4G + Framework Forum	31,500JPYen	Japanese only
D course	IEEE802 Wireless Technology Forum	31,500JPYen	Japanese only
E course	Bluetooth Forum	Free	Japanese only
F course	ZigBee Forum	Free	Japanese only

For other conference courses and details, please visit to the official web site

<http://www.wjexpo.com>

Exhibitor List (As of 11.June.2008)

- A.I. Corp.
- ABIT Corp.
- Agilent Technologies Japan, Ltd.
- Alvarion K.K.
- Andrew Japan KK
- ARM K.K.
- Artiza Networks, Inc.
- AWS Inc.
- Ayudante, Inc.
- BCN Inc.
- Bluetooth SIG
- Broadleaf Co., Ltd.
- Cantata Japan, Inc
- CEST
- CETECOM Japan K. K.
- Chang Zhou Amphenol Fuyang Communications Equipment Co., Ltd. / Amphenol Japan Ltd.
- Con-X Corp.
- Cornes Dodwell Ltd.
- Couei Corp.
- Crossbow Japan Ltd.
- D2 Communications Inc.
- DENKEI-SHIMBUN
- Dempa Times
- Denso Tokyo Inc.
- Digi International K.K.
- Eizo Shimburn, Inc.
- E2 Publishing Corp.
- Epoch Microelectronics, Inc.
- Euretechnos Co., Ltd.
- Extricom Inc.
- Focus Enhancements Japan K.K.
- FUJITSU Ltd. / Fujitsu Microelectronics Ltd. / FUJITSU NETWORK SOLUTIONS Ltd.
- Furuno Electric Co., Ltd
- Futaba Corp.
- Geisha Tokyo Entertainment Inc.
- G-mode Co., Ltd.
- GreenPeak Technologies NV
- Hitachi Business Solutions Co., Ltd.
- Hitachi Kokusai Electric Inc.
- Hitachi Plant Technologies, Ltd.
- Hitachi, Ltd.
- HUAWAI TECHNOLOGIES JAPAN K.K
- iAnywhere Solutions, Inc.
- IBS Japan Co.,Ltd
- IMJ mobile Inc.
- Impress R&D
- INCOM Co.,Ltd.
- Infineon Technologies Japan K.K.
- Internet Initiative Japan Inc.
- IPNetfusion K.K.
- ISB Corp.
- ITOCHU Techno-Solutions Corp.
- Industry Academia Government of YOKOSUKA CITY ITS21
- Keihin Electric Express Railway Co., Ltd
- The University of Electro-Communications
- The University of Tokyo
- Tokyo Institute of Technology
- YOKOSUKA CITY
- Japan Cable and Telecommunications Association
- Japan Radio Co.,Ltd.
- J-Magic, Inc.
- KAGA ELECTRONICS CO., LTD / himico Solutions, Inc. / Ralink / Xronet
- Kanematsu Communications Ltd.
- KDDI Corp.
- KITAMURA MANUFACTURING CO., LTD.
- Kodon Electronics Co., Ltd.
- KT Corp.
- KYOCERA Corp.
- Lightwell Co., Ltd.
- LX
- Map Motion
- MCCI
- Mobile Contents Technical Partnership (MCTP)
- Medical Electronic Science Institute Co., Ltd.
- Menix Co., Ltd.
- Microwave Absorbers Inc.
- MIMO-Mesh Sensor Network Research Project (Tokyo Institute of Technology, Yokohama National University and Yokogawa Electric Co., Ltd.)
- Mitsubishi Electric Engineering Company Limited
- Mobile Computing Promotion Consortium(MCPC)
- Mobile Content Forum (MCF)
- Mobile Marketing Solution Association (MMSA)
- Morito Co., Ltd.
- MTI Ltd.
- MULTISOUP Co., Ltd.
- Navitime Japan Co., Ltd.
- NEC Corp.
- NEC Engineering, Ltd.
- Network Device
- NEXCOM JAPAN Co. Ltd
- Nihon Dengyo Kosaku Co. Ltd
- Nikkei Business Publication, Inc.
- Nordic Semiconductor ASA
- NOX Co.,Ltd
- NTT DoCoMo, Inc.
- NTT NEOMEIT Corp.
- Numonyx Japan
- Oki Electric Industry Co., Ltd.
- Panasonic Mobile Communication Co., Ltd. / Matsushita Electric Industrial Co., Ltd. / Panasonic Network Services Inc.
- Para. TV Company
- pcPhase Corp.
- Perfect Tech R&D
- QUALCOMM Inc.
- Railway Information Systems Co.,Ltd.
- Red Bend Software Japan K.K.
- Reed Business Information Japan K.K.
- REPIC CORPORATION / HUBER+SUHNER
- Runcom Technologies Ltd.
- Ryoden Trading Co., Ltd. / Integration Associates
- Samsung Electronics Co Ltd
- SEKI TECHNOOTRON Corp.
- Sharp Corp.
- Skyley Networks, Inc.
- SORUN Corp.
- Sonus Networks Inc.
- Sophia Mobile, Ltd. / SEARS Co., Ltd
- Spansion Japan Ltd.
- Spectec Computer Co.,Ltd.
- Staccato Communications Inc.
- Systems Engineering Consultants Co., Ltd.
- Tektronix Japan, Ltd.
- Telecom Engineering Center
- Tepco Uquest, Ltd.
- Texas Instruments Japan Ltd.
- The University of Electro-Communications
- TOKIMEC INC.
- TOPPAN FORMS CO., Ltd.
- TRANGO Virtual Processors
- Trend Micro Inc.
- TRIANZ CONSULTING PRIVATE LTD.
- Tsushin Kogyo Shimburn
- UbiNavi Co., Ltd.
- Ubiquitous Entertainment Inc.
- WILLCOM, Inc.
- WiMAX Forum Pavilion
- Agilent Technologies Japan Ltd.
- ArrayComm International LLC
- AT4 wireless
- FUJITSU LIMITED Fujitsu Microelectronics Ltd.
- Hitachi Ltd.
- Intel Corp.
- Japan Radio Co., Ltd.
- Koza Keikaku Engineering Inc.
- Mitsubishi Electric Corp.
- NEC Corp.
- SUMITOMO ELECTRIC NETWORKS, INC.
- WiMAX Forum
- Wireless Technologies, Inc.
- Wisair Japan
- XSURGE Inc.
- YAPPA Corp.
- Yokosuka Telecom Research Park, Inc. (YRP)
- YKC corporation
- ZigBee Alliance / ZigBee SIG Japan
- Ad-Sol Nissin Corp.
- ATMEL Corp.
- Daintree Networks
- Digi International K.K.
- Ember Corp.
- Freescale Semiconductor Japan Ltd.
- Jennic Ltd
- MeshNetics
- NEC Engineering, Ltd.
- Oki Electric Industry Co., Ltd.
- OS Technology, Inc.
- Renesas Technology Corp.
- Texas Instruments Japan Ltd.
- TÜV Rheinland Japan Ltd.
- ZTE Corp.

Organizer : EJK Japan, Ltd. / RIC TELECOM Co., Ltd.

Endorse by (tentative) : Ministry of Internal Affairs and Communications / The ITU Association of Japan Inc. / Association of Radio Industries & Business / Telecommunications Carriers Association / Internet Association Japan / YRP R&D Promotion Committee / ASP SaaS Industry Consortium Japan / NPO Japan Network Security Association / Next Generation Electronics Commerce Promotion Council of Japan (ECOM) / Digital Content Association of Japan / Japan Internet Providers Association / Japan Automatic Identification Systems Association / Japan IC Card System Application Council / Japan Cable and Telecommunications Association / The Institute of Administrative Information Systems / The association for Promotion of Digital Broadcasting / Support Center for Advanced Telecommunications Technology Research / Communications and Information Network Association of Japan (CIAJ) / IT coordinators Association (ITCA)

Supported by (tentative) : Mobile Content forum (MCF) / Mobile Computing Promotion Consortium (MCPC) Mobile Marketing Solution Association (MCPC) / Japan Marketing Association (JMA) / ZigBee Alliance / ZigBee SIG-J / Bluetooth SIG / WiMAX Forum

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